BLA9H0912L(S)-700; BLA9H0912L(S)-700G Power LDMOS transistor Rev. 1 — 24 May 2019

AMMPLEON

Product data sheet

Product profile

1.1 General description

700 W LDMOS power transistor for avionics applications in the frequency range from 960 MHz to 1215 MHz.

Typical information Table 1.

Typical RF performance at T_{case} = 25 °C; t_{D} = 50 μ s; δ = 2 %; I_{Da} = 100 mA; in a class-AB demo circuit.

Test signal	f	V _{DS}	P_L	G _p	ησ
	(MHz)	(V)	(W)	(dB)	(%)
pulsed RF	1030	50	700	20	62

1.2 Features and benefits

- High efficiency
- Excellent ruggedness
- Designed for avionics band operation
- Excellent thermal stability
- Easy power control
- Integrated dual sided ESD protection enables excellent off-state isolation
- High flexibility with respect to pulse formats
- Internally matched for ease of use
- For RoHS compliance see the product details on the Ampleon website

1.3 Applications

Avionics transmitter applications in the frequency range from 960 MHz to 1215 MHz

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
BLA9H0912L	-700 (SOT502A)		
1	drain		
2	gate		1
3	source [1]	2 3	2
			3 sym112
BLA9H0912L	S-700 (SOT502B)	•	
1	drain		
2	gate	3	1
3	source [1]	2	2 — 3 3 sym112
BLA9H0912L	-700G (SOT502F)		
1	drain	1	
2	gate		1
3	source [1]	$\begin{bmatrix} 2 & 3 \\ 2 & 3 \end{bmatrix}$	2 — 3 sym112
BLA9H0912L	S-700G (SOT502E)		1
1	drain	,	
2	gate		1
3	source [1]	2 3	2 — 3 3 sym112

^[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Packag	ackage					
	Name	Description	Version				
BLA9H0912L-700	-	flanged ceramic package; 2 mounting holes; 2 leads	SOT502A				
BLA9H0912LS-700	-	earless flanged ceramic package; 2 leads	SOT502B				
BLA9H0912L-700G	-	eared flanged ceramic package; 2 leads; 2 mounting holes	SOT502F				
BLA9H0912LS-700G	-	earless flanged ceramic package; 2 leads	SOT502E				

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	106	V
V_{GS}	gate-source voltage		-6	+11	V
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[1]	-	225	°C

^[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
Z _{th(j-c)}	transient thermal impedance from junction	T _{case} = 85 °C; P _L = 700 W		
	to case	$t_p = 32 \ \mu s; \ \delta = 2 \ \%$	0.055	K/W
		t_p = 10 μ s; δ = 10 %	0.068	K/W
		$t_p = 64 \ \mu s; \ \delta = 1 \ \%$	0.076	K/W
		t_p = 2.4 ms; δ = 6.4 %	0.24	K/W

6. Characteristics

Table 6. DC characteristics

 T_i = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 4 \text{ mA}$	106	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$V_{DS} = 10 \text{ V}; I_{D} = 400 \text{ mA}$	1.5	2.0	2.5	V
I _{DSS}	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 50 \text{ V}$	-	-	2.8	μА
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	60	-	A
I _{GSS}	gate leakage current	$V_{GS} = 11 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	280	nA
9 _{fs}	forward transconductance	$V_{DS} = 10 \text{ V}; I_D = 400 \text{ mA}$	-	3.7	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 14 A$	-	0.060	-	Ω

Table 7. RF characteristics

Test signal: pulsed RF; f = 1030 MHz; t_p = 50 μ s; δ = 2 %; RF performance at V_{DS} = 50 V; I_{Dq} = 100 mA; T_{case} = 25 °C; unless otherwise specified, in a class-AB production circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
G _p	power gain	P _L = 700 W	19	20	-	dB
η_{D}	drain efficiency	P _L = 700 W	59	62	-	%
RLin	input return loss	P _L = 700 W	-	-15	-	dB
P _{droop(pulse)}	pulse droop power	P _L = 700 W	-	0.2	0.5	dB
P _{L(2dB)}	output power at 2 dB gain compression		-	725	-	W

7. Test information

7.1 Ruggedness in class-AB operation

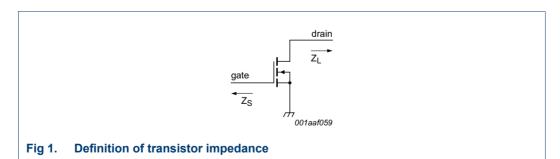
The BLA9H0912L-700, BLA9H0912LS-700, BLA9H0912L-700G and BLA9H0912LS-700G are capable of withstanding a load mismatch corresponding to VSWR = 20 : 1 through all phases under the following conditions: V_{DS} = 50 V; I_{Dq} = 100 mA; P_L = 700 W; t_p = 50 μ s; δ = 2 %.

7.2 Impedance information

Table 8. Typical impedance

Typical values unless otherwise specified.

f	Z _S	Z_L
(MHz)	(Ω)	(Ω)
950	0.717 – j1.793	0.965 – j1.305
1000	0.953 – j1.886	1.049 – j1.561
1050	1.091 – j1.910	1.032 – j1.780
1100	1.353 – j0.443	1.291 – j1.952
1150	1.962 – j1.061	1.474 – j2.081
1200	0.837 – j0.936	1.514 – j2.413



7.3 Test circuit

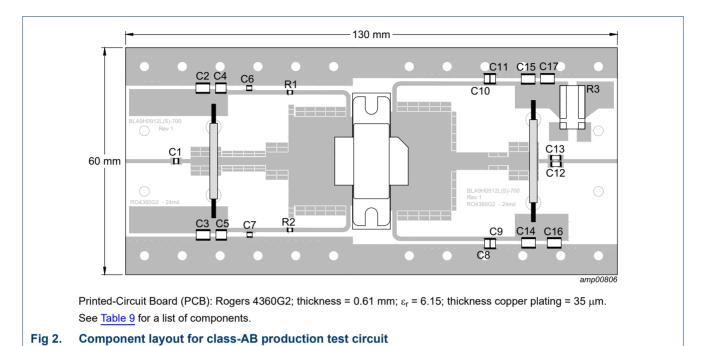
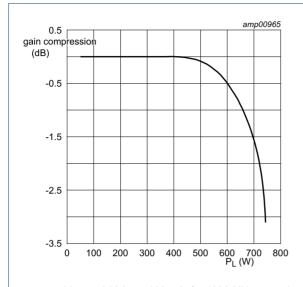


Table 9. Demo test circuit list of components See Figure 2 for component layout.

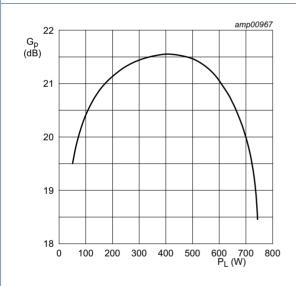
Component	Description	Value	Remarks
C1	multilayer ceramic chip capacitor	62 pF	ATC 100A
C2, C3, C16, C17	multilayer ceramic chip capacitor	4.7 μF, 100 V	GMR42 258K7S 475K 100 H53
C4, C5, C14, C15	multilayer ceramic chip capacitor	1 nF	ATC 100B
C6, C7	multilayer ceramic chip capacitor	200 pF	ATC 800B
C8, C9, C10, C11, C12, C13	multilayer ceramic chip capacitor	68 pF	ATC 800B
R1, R2	resistor	5.1 kΩ	SMD 0603
R3	resistor	10 mΩ	FC4L110R010FER

7.4 Graphical data



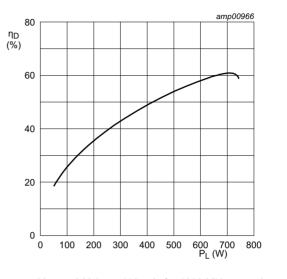
 V_{DS} = 50 V; I_{Dq} = 100 mA; f = 1030 MHz; t_p = 50 $\mu s;$ δ = 2 %.

Fig 3. Gain compression as a function of output power; typical values



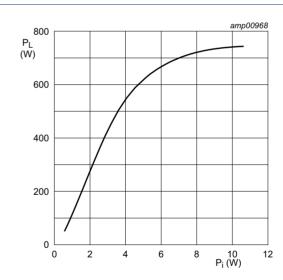
 V_{DS} = 50 V; I_{Dq} = 100 mA; f = 1030 MHz; t_p = 50 $\mu s;$ δ = 2 %.

Fig 5. Power gain as a function of output power; typical values



 V_{DS} = 50 V; I_{Dq} = 100 mA; f = 1030 MHz; t_p = 50 $\mu s;$ δ = 2 %.

Fig 4. Drain efficiency as a function of output power; typical values



 V_{DS} = 50 V; I_{Dq} = 100 mA; f = 1030 MHz; t_p = 50 μs ; δ = 2 %

Fig 6. Output power as a function of input power; typical values

8. Package outline

Flanged ceramic package; 2 mounting holes; 2 leads

SOT502A

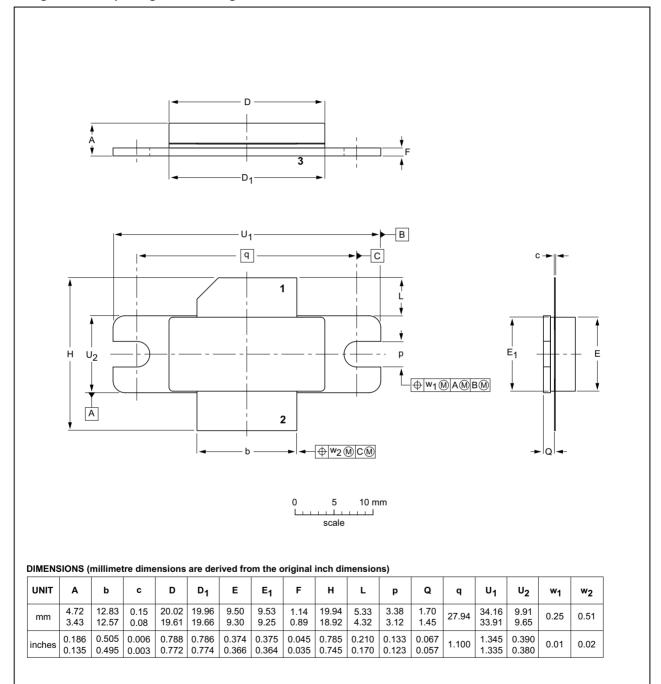


Fig 7. Package outline SOT502A

IEC

OUTLINE

VERSION

SOT502A

JEITA

REFERENCES

JEDEC

ISSUE DATE

03-01-10

12-05-02

EUROPEAN

PROJECTION

Earless flanged ceramic package; 2 leads

SOT502B

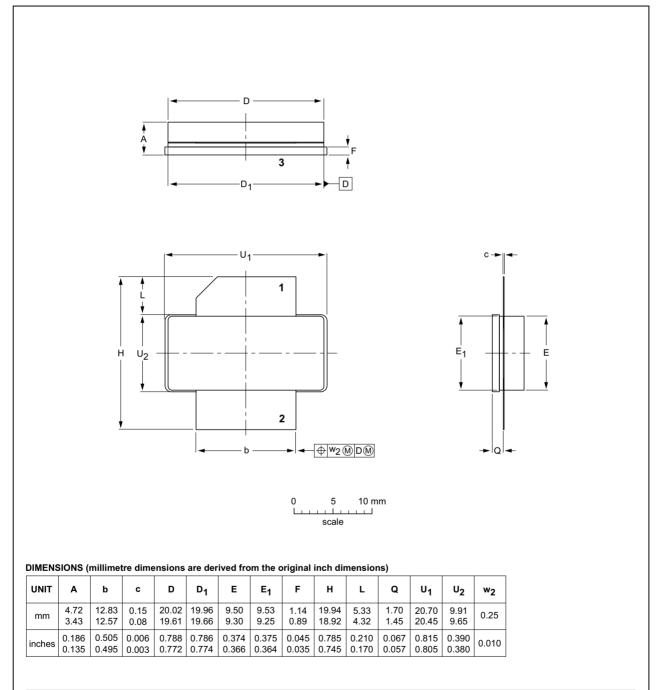


Fig 8. Package outline SOT502B

IEC

OUTLINE

VERSION

SOT502B

JEITA

REFERENCES

JEDEC

ISSUE DATE

07-05-09

12-05-02

EUROPEAN

PROJECTION

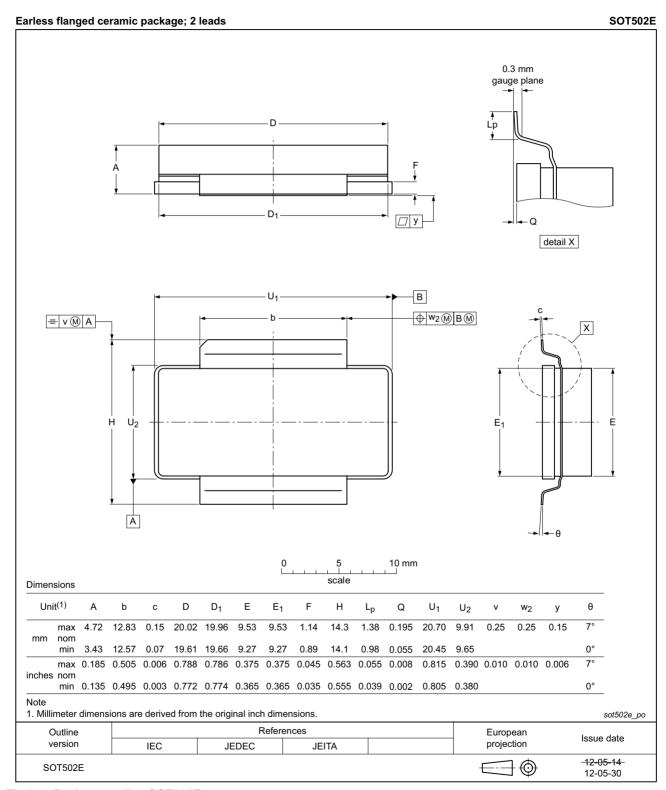


Fig 9. Package outline SOT502E

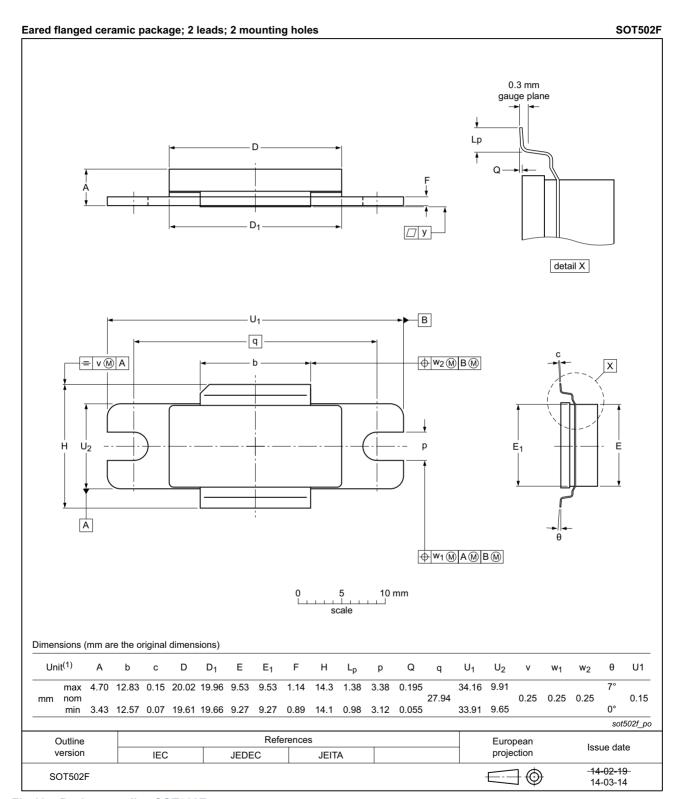


Fig 10. Package outline SOT502F

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 10. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C2A [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	2 [2]

- [1] CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V.
- [2] HBM classification 2 is granted to any part that passes after exposure to an ESD pulse of 2000 V.

10. Abbreviations

Table 11. Abbreviations

Acronym	Description
ESD	ElectroStatic Discharge
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MTF	Median Time to Failure
RoHS	Restriction of Hazardous Substances
SMD	Surface Mounted Device
VSWR	Voltage Standing-Wave Ratio

11. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLA9H0912L-700_LS-700_L-700G_LS-700G v.1	20190524	Product data sheet		-

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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BLA9H0912L-700_LS-700_L-700G_LS-700G

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BLA9H0912L(S)-700(G)

Power LDMOS transistor

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Power LDMOS transistor

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